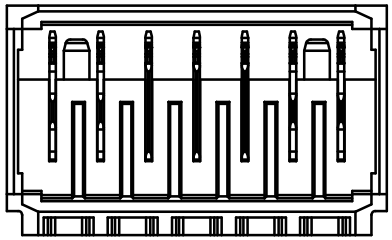
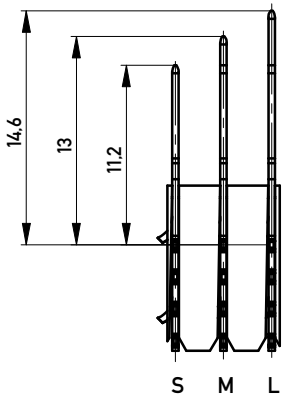
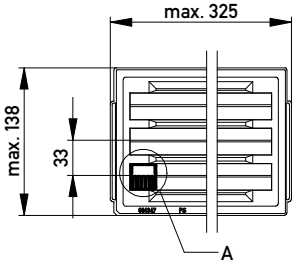


Kontaktübersicht:
contacts overview

L = lang / *long*
M = mittel / *middle*
S = kurz / *short*



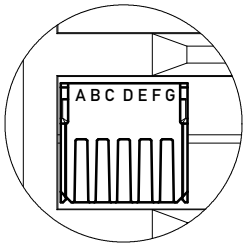


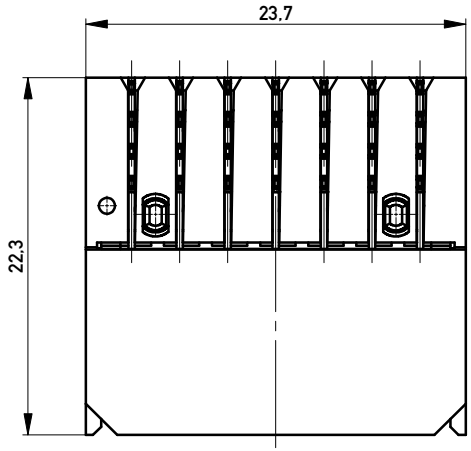
M 1 : 5

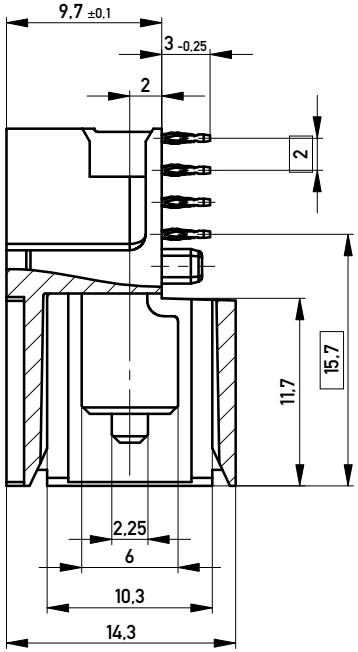
verpackt in Tray
VPE: 36 St.

tray packaging
packaging unit 36 pcs.

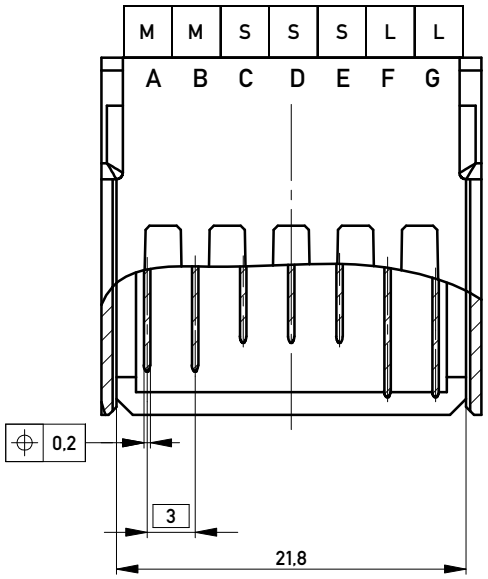
DETAIL A
MAßSTAB 1 : 1





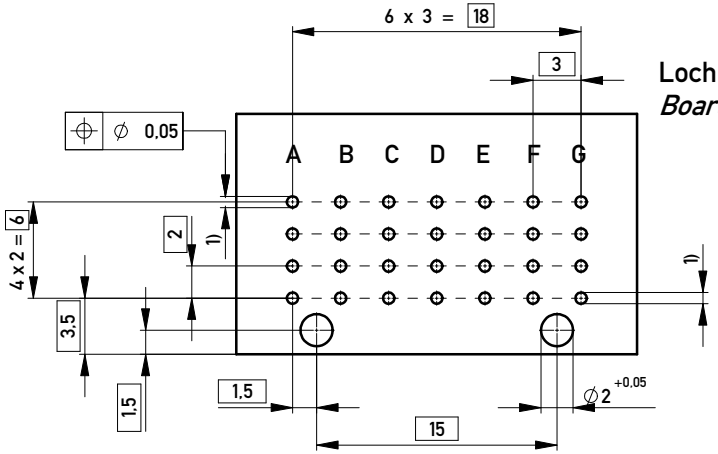


Bestückungsplan
contact layout



Gehäuse / *housing*: PBTP grau 30% GF / *PBTP gray 30 %GF*
Kontakte / *contacts*: Phosphor Bronze / *phosphor bronce*

Oberflächenbeschichtung / *plating:*
Kontaktbereich
/ *mating area:* 2-3 µm Ni 1,2 µm Au
Anschlussbereich
/ *termination*: 2-3 µm Ni 1 µm Sn matt



Lochbild für Leiterplatte
Board hole pattern

1) ⌀0,6 ±0,05 Durchmesser des metallisierten Loches
⌀ 0,6 ±0,05 Diameter of finished plated-through hole

Schichtaufbau im metallisierten Loch siehe Zeichnung 114406 / 164062 Nr.1
Metal plating of planted-through hole see drawing 114406 / 164062 Nr.1

Anforderungsstufe 1
class 1

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Information:	Tolerances: All Dimensions in mm	Scale 3:1	
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		Class ERMPM	